## **Si4126DY**

## Vishay Siliconix



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30			٧	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J 050A		24		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	- I <sub>D</sub> = 250 μA		- 6.4			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	1.0		2.5	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zawa Cata Waltana Duain Courset	-	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V			1	, . A	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			10	μΑ	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α	
	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A		0.0022	0.00275	Ω	
Drain-Source On-State Resistance <sup>a</sup>		$V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$		0.0027	0.0034		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 15 A		75		S	
Dynamic <sup>b</sup>				L	l l		
Input Capacitance	C <sub>iss</sub>			4405			
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		760		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>	30 30		285			
		V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A		70	105	nC	
Total Gate Charge				30	45		
Gate-Source Charge	$Q_{gs}$	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 20 \text{ A}$		10.2			
Gate-Drain Charge	Q <sub>gd</sub>			7.4			
Gate Resistance	$R_g$	f = 1 MHz	0.3	1.4	2.8	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			36	60		
Rise Time	t <sub>r</sub>	$V_{DD} = 15 \text{ V}, R_{L} = 1.5 \Omega$		20	40	ns	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		53	90		
Fall Time	t <sub>f</sub>			24	40		
Turn-On Delay Time	t <sub>d(on)</sub>			15	30		
Rise Time	t <sub>r</sub>	$V_{DD} = 15 \text{ V}, R_{L} = 1.5 \Omega$		10	20		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		43	70		
Fall Time	t <sub>f</sub>	1		10	20		
Drain-Source Body Diode Characteristi	cs						
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			7.0		
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				70	Α	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 3 A		0.71	1.1	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			38	60	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	1 10 4 15/11 100 1/ 7 5-00		38	60	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		19		ns	
Reverse Recovery Rise Time	t <sub>b</sub>	1		20			

#### Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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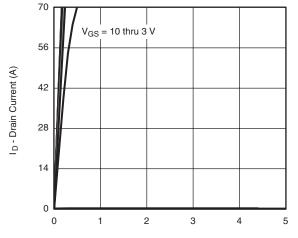
a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %

b. Guaranteed by design, not subject to production testing.



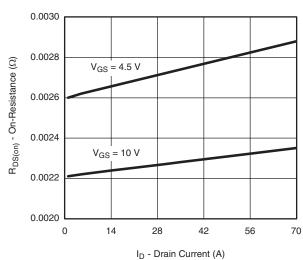
## Vishay Siliconix

#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

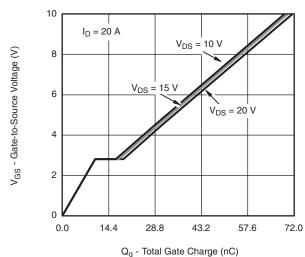


V<sub>DS</sub> - Drain-to-Source Voltage (V)

#### **Output Characteristics**



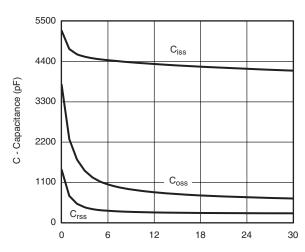
On-Resistance vs. Drain Current and Gate Voltage



Gate Charge

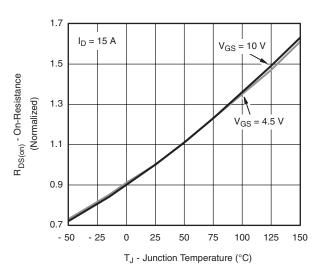
V<sub>GS</sub> - Gate-to-Source Voltage (V)

#### **Transfer Characteristics**



V<sub>DS</sub> - Drain-to-Source Voltage (V)

#### Capacitance



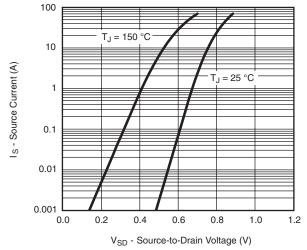
On-Resistance vs. Junction Temperature

## **Si4126DY**

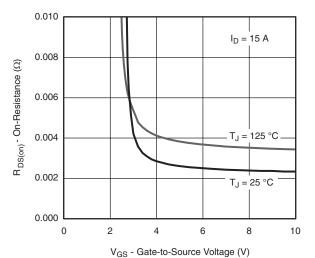
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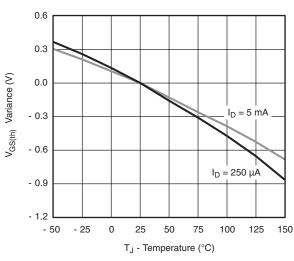
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



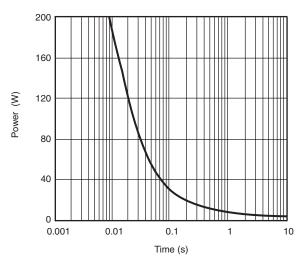
Source-Drain Diode Forward Voltage



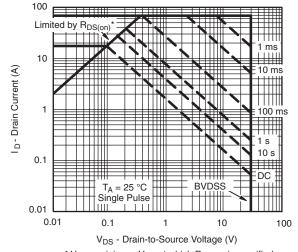
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 



Single Pulse Power, Junction-to-Ambient



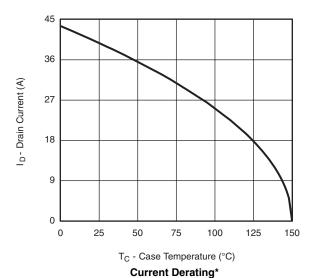
 $^{\star}$   $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

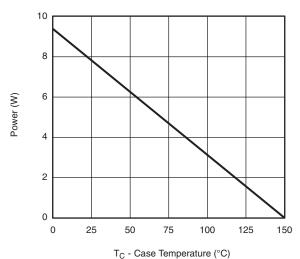
Safe Operating Area, Junction-to-Ambient



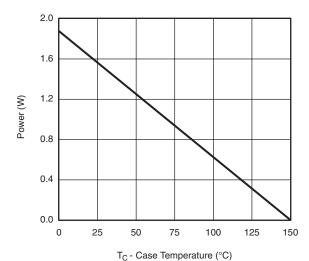
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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





Power Derating, Junction-to-Case



Power, Junction-to-Ambient

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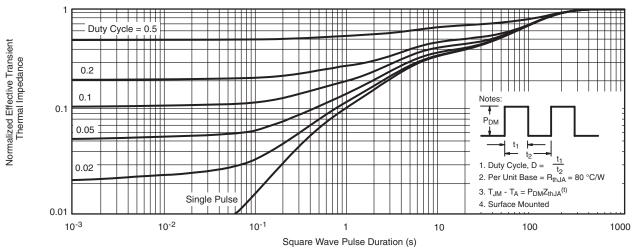
<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

## **Si4126DY**

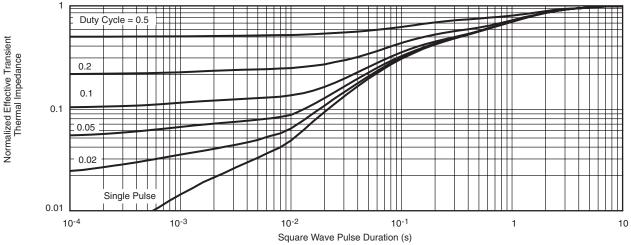
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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



#### Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

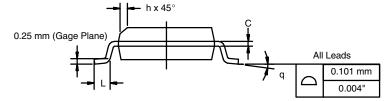
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**SOIC (NARROW): 8-LEAD** JEDEC Part Number: MS-012







	MILLIM	IETERS	INCHES					
DIM	Min	Max	Min	Max				
Α	1.35	1.75	0.053	0.069				
A <sub>1</sub>	0.10	0.20	0.004	0.008				
В	0.35	0.51	0.014	0.020				
С	0.19	0.25	0.0075	0.010				
D	4.80	5.00	0.189	0.196				
Е	3.80	4.00	0.150	0.157				
е	1.27	BSC	0.050 BSC					
Н	5.80	6.20	0.228	0.244				
h	0.25	0.50	0.010	0.020				
L	0.50	0.93	0.020	0.037				
q	0°	8°	0°	8°				
S	0.44	0.64	0.018	0.026				
ECN: C-06527-Rev. I. 11-Sep-06								

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



#### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOT

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